

**MICROCHIP**  
The Embedded Control Solutions Company®**Product / Process Change Archive****Product / Process Change Notification SPOL-7GM26P**[Home](#)

The information below reflects a change that is being implemented.

Notice Date:

07/18/2008

Product Category:

Linear Devices; Mixed Signal Devices; Power Management; CAN Communication; PIC12xxx; RFID; SDP

Notification Subject:

CCB#832: QUALIFICATION OF LARGER PADDLE SIZE 160x225 MILS FOR 14L PDIP PACKAGE AT VIGILANT, THAILAND (VGT)

Notification Body:

PCN Status:

Initial Notification

Microchip Part#s Affected (please see the link for these files at the end of this PCN):

[CCB 832\\_Microchip Catalog Part#s Affected.xls](#)

[CCB 832\\_Microchip Catalog Part#s Affected.pdf](#)

Description of Change:

Qualification of larger paddle size

Impacts to Data Sheet:

None

Reason for Change:

To increase manufacturing capacity

Change Implementation Status:

In progress

Estimated Change Implementation Date(s):

August 31, 2008 (Date Code: 0835)

Markings to Distinguish Revised From Unrevised Devices: (e.g.: Date Code, Device Marking, Ship Container Marking)

Traceability code

Attachment(s):

[CCB 832\\_Microchip Catalog Part#s Affected.xls](#)

[CCB 832\\_Microchip Catalog Part#s Affected.pdf](#)

**Microchip Catalog Part#s Affected\_Single die**

PIC12F675-ICD/P  
PIC12F683-ICD/P  
TC4467CPD  
TC4467EPD  
TC4468CPD  
TC4468EPD  
TC4469CPD  
TC4469EPD  
HCS1370-I/P  
HCS1370/P  
HCS370-I/P  
HCS370/P  
TC520ACPD  
MCP25020-E/P  
MCP25020-I/P  
MCP25025-I/P  
MCP25050-E/P  
MCP25050-I/P  
MCP25055-I/P  
MCP2030-I/P  
TC7652CPD  
MCP6024-E/P  
MCP6024-I/P  
MCP609-I/P  
MCP619-I/P  
MCP6144-E/P  
MCP6144-I/P  
MCP6544-E/P  
MCP6544-I/P  
MCP6549-E/P  
MCP6549-I/P

**Microchip Catalog Part#s Affected\_Dual Die**

HCS473/P

HCS473-I/P

HCS515-I/PA56

HCS515-I/P022

HCS515-I/P

HCS515/P